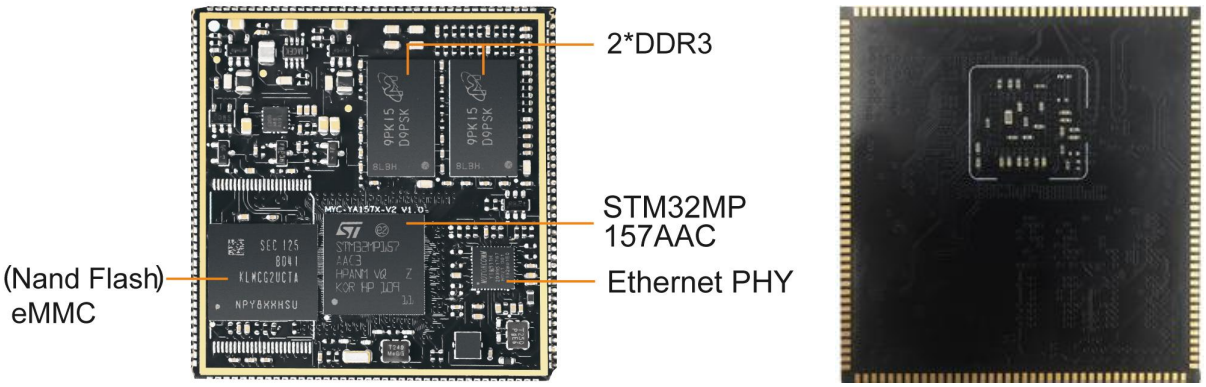
MYC-YA157C-V3 System-On-Module Overview

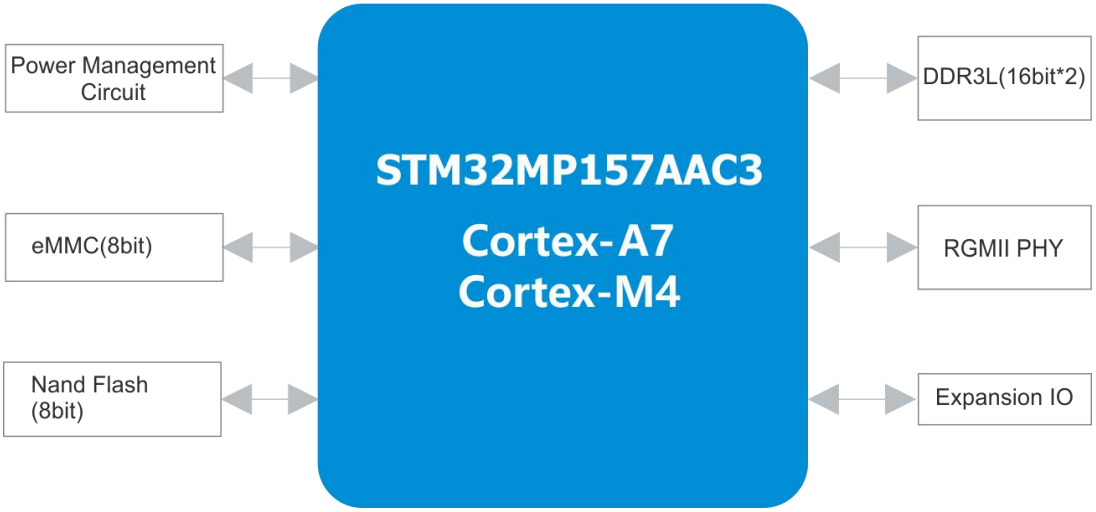
- ✓ *STMicroelectronics STM32MP1 MPU based on 650MHz Dual Arm Cortex-A7 and 209MHz Cortex-M4 Cores*
- ✓ *512MB DDR3, 4GB/8GB eMMC Flash*
- ✓ *On-board Gigabit Ethernet PHY*
- ✓ *1.0mm pitch 164-pin Stamp Hole Expansion Interface*
- ✓ *Supports Running Linux*

Measuring only 45mm by 43mm, the **MYC-YA157-V3 SOM** is a compact **ST STM32MP1** powered System-on Module (SoM) that combines the **STM32MP157** processor (**STM32MP157AAC3**), 512MB DDR3, 4GB/8GB eMMC as well as an integrated GigE PHY chip. A number of peripherals and IO signals are brought out through 1.0 mm pitch 164-pin stamp-hole (Castellated-Hole) expansion interface to make the module an excellent embedded controller for your system integration. Typical applications are industrial control, consumer electronics, smart home, medical and more other energy-efficient applications which require rich performance and low power.



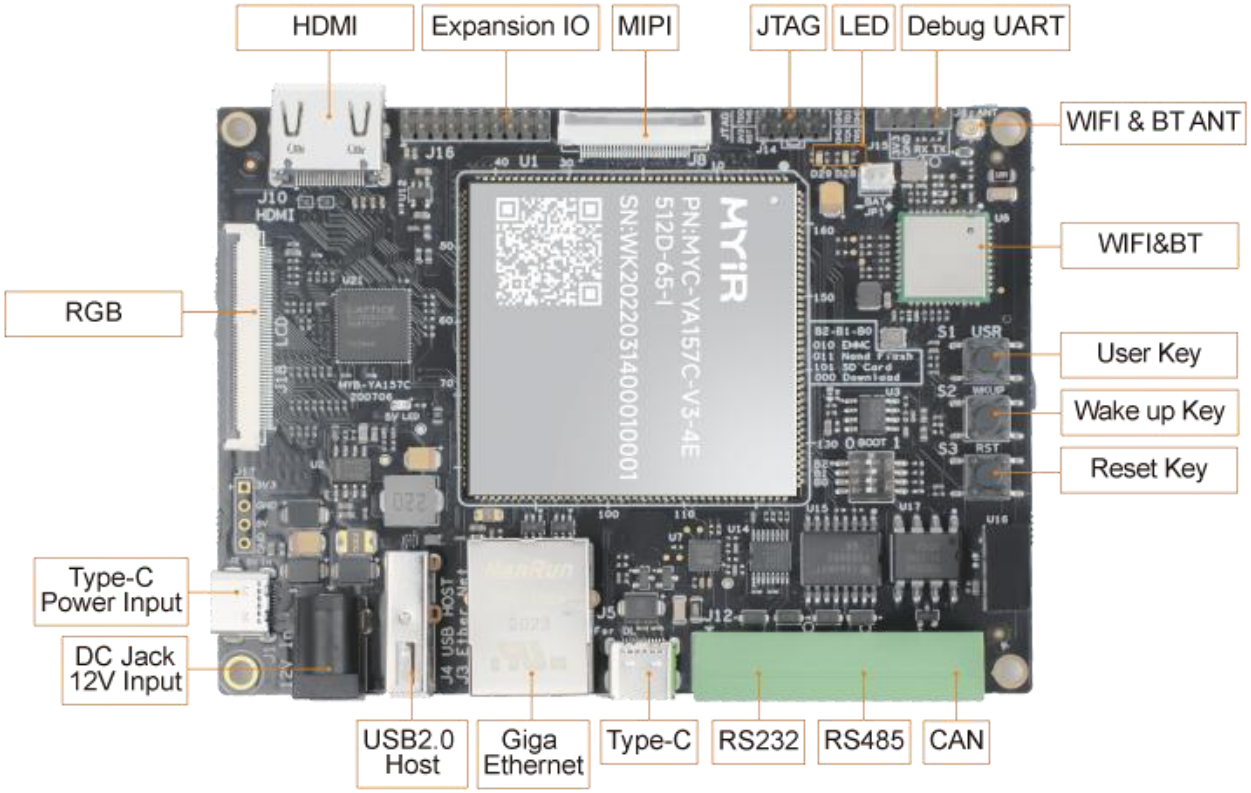
MYC-YA157C-V3 without shielding cover (Top-view and Bottom-view)

The **MYC-YA157C-V3** is running Linux OS. Based on Linux 5.4.31 kernel, MYIR provides abundant software resources for Yocto 3.1 based MYIR MEasy-HMI system, ST Weston system and MYIR MEasy-IOT system as well as Ubuntu 18.04 system including kernel and driver source code, STM32CubeProgrammer and STM32CubeMX tools to enable users to start their development rapidly and easily.

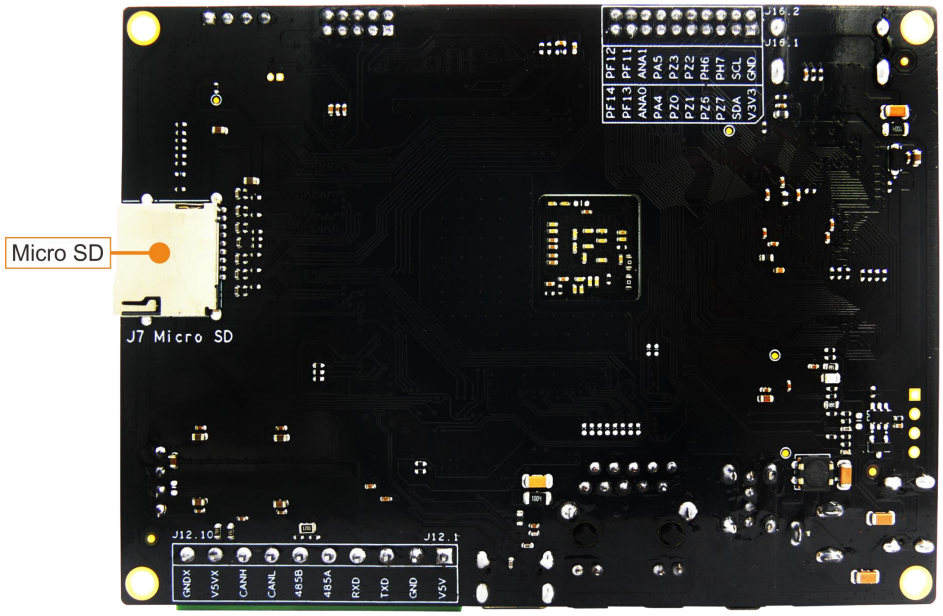


MYC-YA157C-V3 Function Block Diagram

The **MYD-YA157C-V3 Development Board** is built around the **MYC-YA157C-V3**. It takes full advantages of the STM32MP157A MPU to explore a rich set of peripherals and interfaces to the base board including RS232, RS485, USB Type-C DRP, USB2.0 HOST, Gigabit Ethernet, WiFi/Bluetooth, CAN, Micro SD Card Slot, JTAG, RGB888 based LCD/HDMI, MIPI-DSI, etc. The **MYD-YA157C-V3 Development Board** is delivered with one Quick Start Guide, one Type-C cable, one USB to TTL serial cable and one WiFi/Bluetooth antenna to provide user a complete platform for evaluating and prototyping based on STM32MP1 series microprocessors. MYIR also offers **MY-TFT070CV2 LCD Module** and MY-CAM002U Camera Modules as add-on options for the board.



MYD-YA157C-V3 Development Board (Top-view)



MYD-YA157C-V3 Development Board (Bottom-view)

Hardware Specification

The MYC-YA157C-V3 is using STMicroelectronics **STM32MP157AAC3** Microprocessor with 12 x 12 mm, 0.5 mm pitch, TFBGA361 package which is among the **STM32MP1 Series**. The STM32MP1 series is based on a heterogeneous single or dual Arm Cortex-A7 and Cortex-M4 cores architecture, strengthening its ability to support multiple and flexible applications, achieving the best performance and power figures at any time. The Cortex-A7 core provides access to open-source operating systems (Linux/Android) while the Cortex-M4 core leverages the STM32 MCU ecosystem. It is available in 3 different lines which are pin-to-pin compatible:

- **STM32MP157**: Dual Cortex-A7 cores @ 650 MHz, Cortex-M4 core @ 209 MHz, 3D GPU, DSI display interface and CAN FD
- **STM32MP153**: Dual Cortex-A7 cores @ 650 MHz, Cortex-M4 core @ 209 MHz and CAN FD
- **STM32MP151**: Single Cortex-A7 core @ 650 MHz, Cortex-M4 core @ 209 MHz
  Each line comes with a security option (cryptography & secure boot)

Arm® Cortex®-A7 – 650 MHz

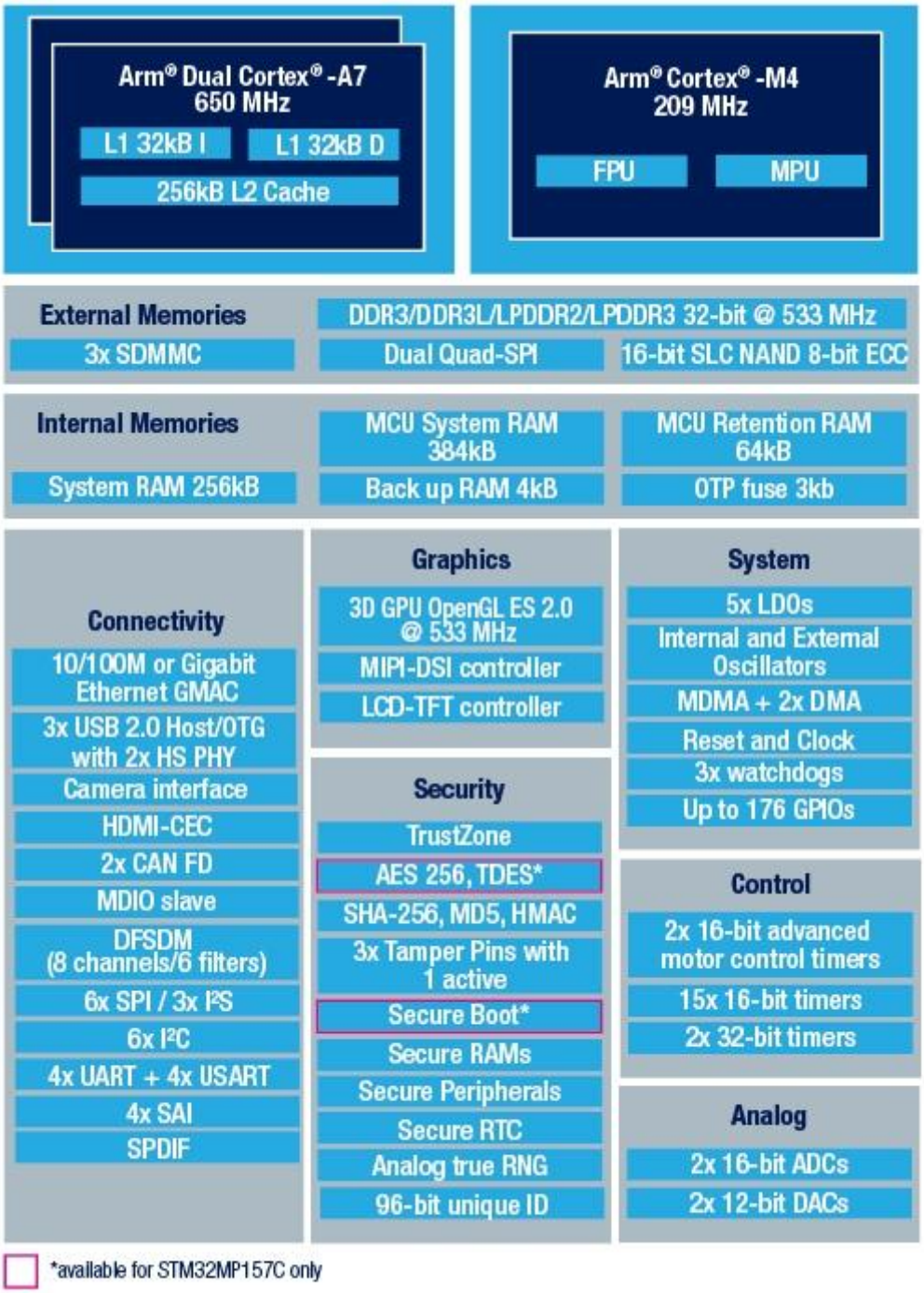
ACCELERATION
- Dual core Arm® Cortex®-A7 processor
- L1 and L2 caches
- 3D Graphic Processing Unit*
- Floating Point Unit + Arm® Neon™
- Arm® Cortex®-M4 209 MHz coprocessor
- MDMA + DMA
- LPDDR2/LPDDR3 16/32**-bit 533 MHz
- DDR3/DDR3L 16/32**-bit 533 MHz

CONNECTIVITY
- 2 x USB2.0 HS Host
- USB2.0 OTG FS/HS
- 3 x SDMMC/SDIO
- USART, UART, SPI, I²C
- 2 x (TT)FD-CAN2.0*
- Gigabit Ethernet IEEE 1588***
- FMC (NAND Flash)
- Camera I/F
- Dual mode Quad-SPI
- DSI 2 Gbit/s*

STM32 MP1 Product lines	Cortex®-A7 core	f_{CPU} (MHz)	Cortex®-M4 core	f_{MCU} (MHz)	3D GPU	f_{GPU} (MHz)	HW Crypto	FD-CAN	MIPI®-DSI
STM32MP151A	1	650	1	209	-	-	-	-	-
STM32MP151C							•		
STM32MP153A	2	650	1	209	-	-	-	2	-
STM32MP153C							•		
STM32MP157A	2	650	1	209	•	533	-	2	•
STM32MP157C							•		

Notes:
* Not available in all product lines
** 16/32-bit for LFBGA448 and TFBGA361 packages, 16-bit only for LFBGA354 and TFBGA257 packages
*** 10/100M Ethernet only for LFBGA354 and TFBGA257 packages

STM32MP1 Series Processors



STM32MP157 Block Diagram

Mechanical Parameters

- Dimensions: 45mm x 43mm
- PCB Layers: 8-layer design
- Power supply: +5V/0.5A
- Working temperature: 0~70 Celsius (commercial grade) or 40~85 Celsius (industrial grade)

Processor

- STMicroelectronics STM32MP157AAC3 Microprocessor
  - Up to 650MHz dual-core Arm Cortex-A7 32-bit RISC core
  - Up to 209MHz Arm Cortex-M4 32-bit RISC core with FPU/MPU
  - Integrated 3D GPU

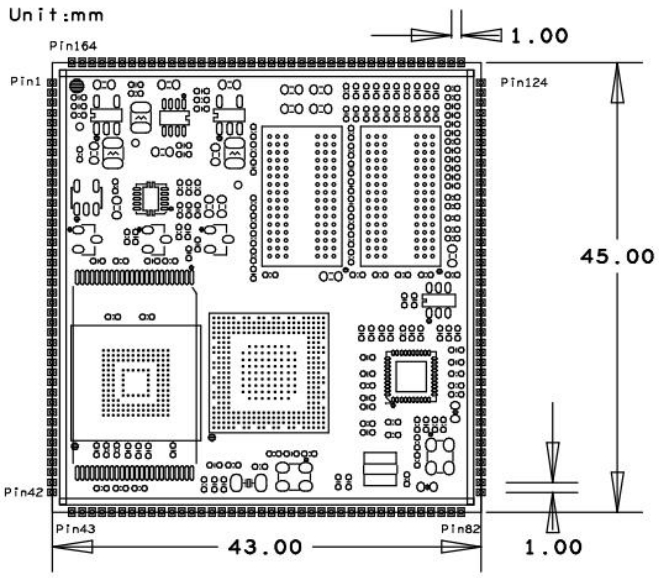
Memory

- 512MB DDR3 (supports up to 1GB DDR3)
- 4GB eMMC Flash (supports up to 64GB eMMC)
- Nand Flash (alternative design with eMMC, supporting 256MB / 512MB /1GB Nand Flash)

Peripherals and Signals Routed to Pins

- One 10/100/1000M Ethernet PHY
- 1.0mm pitch 164-pin Stamp Hole Expansion Interface
  - 8 x Serial ports
  - 6 x I2C
  - 6 x SPI
  - 1 x SAI
  - 1 x USB 2.0 Host and 1 x USB 2.0 OTG
  - 2 x SDIO
  - 2 x CAN
  - 1 x MIPI-DSI
  - 1 x Digital Camera Interface (DCMI)
  - 1 x RGB Interface (supports RGB888, resolution up to 1366 x 768 @60fps)
  - Up to 97 GPIOs

  Note: the peripheral signals brought out to the expansion interface are listed in maximum number. Some signals are reused. Please refer to the processor datasheet and the SOM pinout description file.



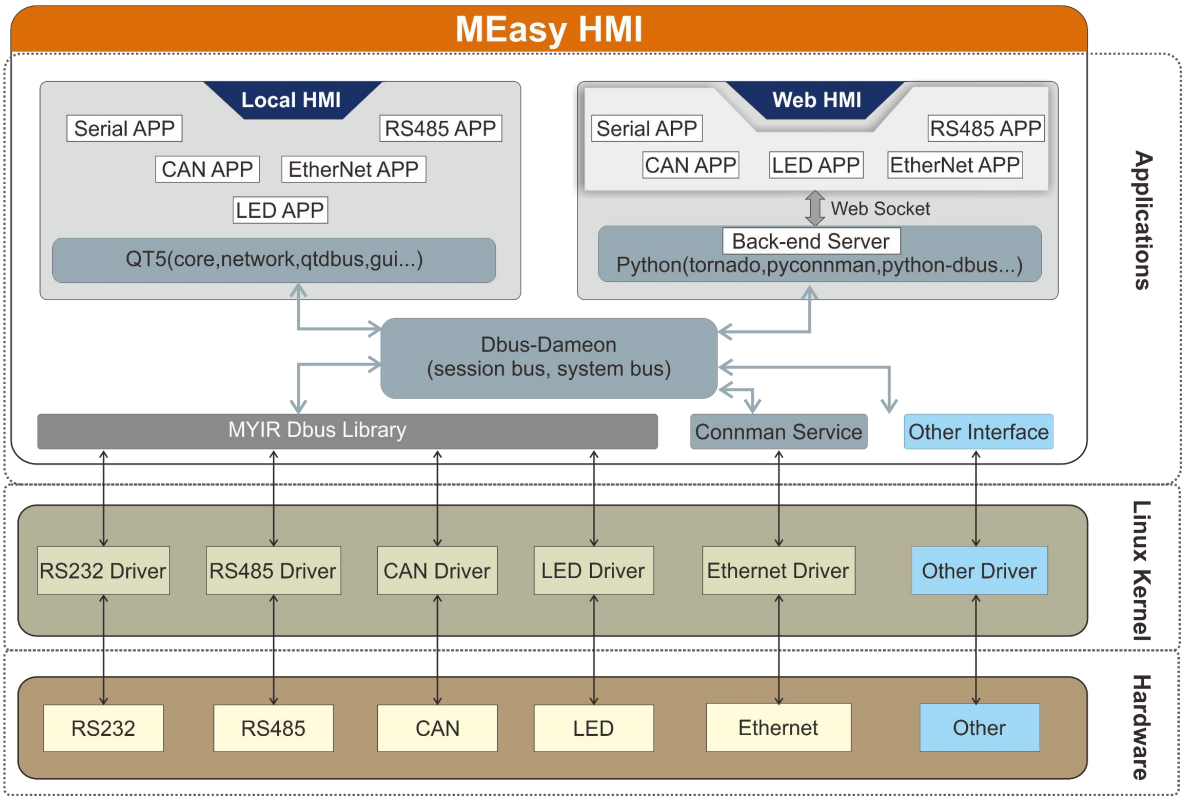
MYC-YA157C-V3 Dimensions Chart

Software Features

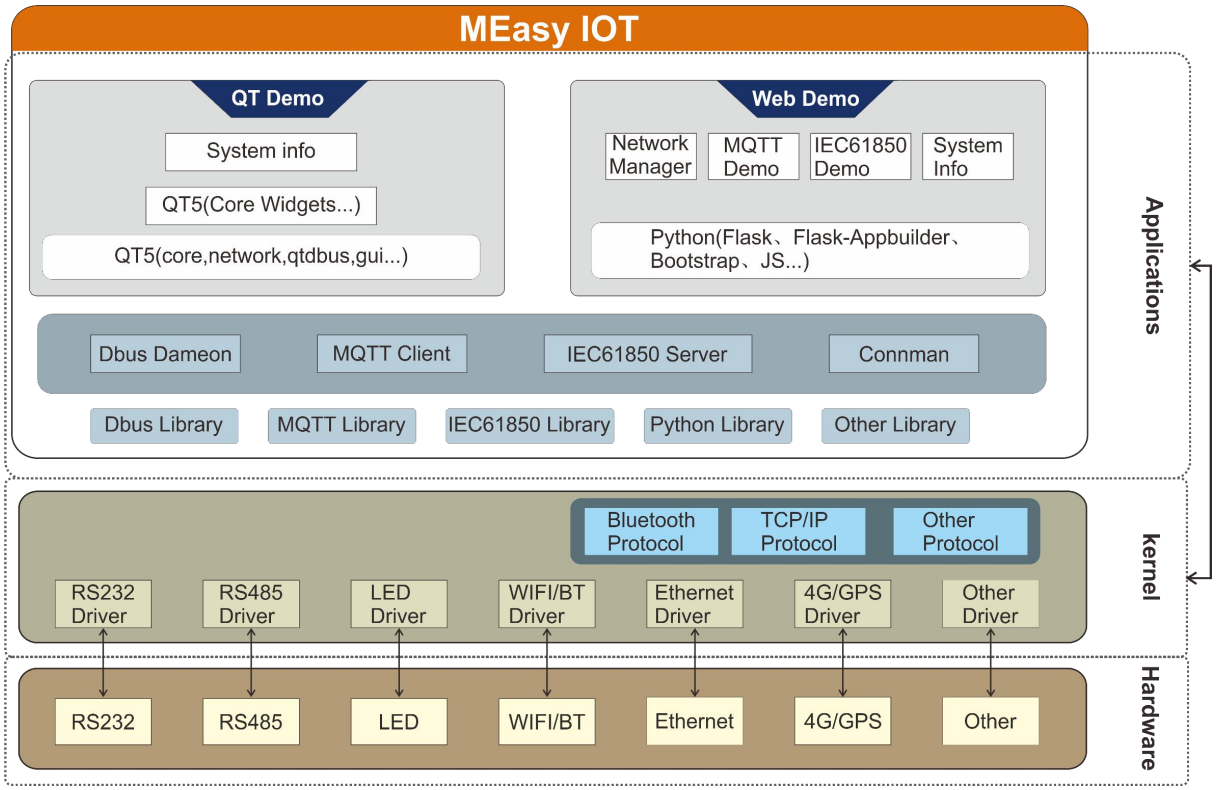
Item	Features	Description	Source Code
Bootstrap program	TF-a-2.2	Arm Trusted Firmware	YES
Bootloader	U-boot-2020.01	Kernel bootstrap	YES
Linux kernel	Linux-5.4.31	Customized based on ST kernel_5.4.31 version for MYD-YA157C-V3	YES
Drivers	Nand Flash	Nand Flash driver	YES
	PMIC	STPMIC driver	YES
	USB Host	USB Host driver	YES
	USB OTG	USB OTG driver	YES
	I2C	I2C driver	YES
	SPI	SPI driver	YES
	Ethernet	10M/100M/1000M Ethernet driver	YES
	MMC	eMMC/TF card driver	YES
	LCD	LCD driver, supports MYIR's 7-inch LCD with 800 x 480 pixels resolution	YES
	HDMI	HDMI driver	YES
	Touch	Capacitive touch screen driver	YES
	PWM	PWM driver	YES
	RTC	RTC driver	YES
	GPIO	GPIO driver	YES
	UART/USART	Serial port driver	YES
	CAN	FDCAN Bus driver	YES
	RS485	RS485 driver	YES
	Camera	USB Camera driver (OV2659)	YES
	WiFi & BT	AP6212 WiFi/BT driver (SDIO)	YES
	Watchdog	Watchdog driver	YES
File system	rootfs	Yocto 3.1 for ST Weston system	YES
	rootfs	Yocto 3.1 for QT5.12 system	YES
	rootfs	MEasy-IOT 1.0 & MEasy_HMI 2.0 demo system developed by MYIR	YES
	Ubuntu core system	Based on ubuntu18.04	YES
Tools	STM32CubeProgrammer	ST programmer software	BIN
	STM32CubeMX	ST configuration integration tool	BIN
Applications	GPIO LED	LED example	YES
	GPIO KEY	KEY example	YES
	NET	TCP/IP Socket C/S example	YES
	RTC	RTC example	YES
	RS232	RS232 example	YES
	RS485	RS485 example	YES
	CAN	CAN example	YES
	LCD	LCD Display example	YES
	Camera	Camera Display example	YES
	UART	UART example	YES
Compiler Tool Chain	Cross compiler	arm-openstlinux_weston-linux-gnueabi	BINARY

MYD-YA157C-V3 Software Features

The MYD-YA157C-V3 runs Linux OS and is provided with software packages. Based on Linux 5.4.31 kernel, MYIR has provided abundant software resources for Yocto 3.1 based MYIR MEasy-HMI system, Yocto 3.1 based ST Weston system, Ubuntu 18.04 system and MYIR MEasy-IOT system including kernel and driver source code, STM32CubeProgrammer and STM32CubeMX tools to enable users to start their development rapidly and easily.



MEasy-HMI System Structure



MEasy-IOT System Structure

Order Information

Product Item	Part No.	Packing List
MYC-YA157C-V3	MYC-YA157C-V3-4E512D-65-C	✓ One MYC-YA157C-V3 SOM
	MYC-YA157C-V3-4E512D-65-I	
	MYC-YA157C-V3-8E512D-65-I	
MYD-YA157C-V3 Development Board	MYD-YA157C-V3-4E512D-65-C	✓ One MYD-YA157C-V3 Development Board ✓ One USB Type-C cable ✓ One USB to UART Serial cable ✓ One WiFi/Bluetooth Antenna ✓ One Quick Start Guide
	MYD-YA157C-V3-4E512D-65-I	
MY-TFT070CV2 LCD Module	MY-TFT070CV2	✓ 7-inch LCD Module with capacitive touch screen
MY-CAM002U Camera Module	MY-CAM002U	✓ USB Camera Module

Note:

1. One MYD-YA157C-V3 Development Board includes one MYC-YA157C-V3 SOM mounted on the base board. If you need more SOMs, you can order extra ones.

2. Bulk discounts are available.

3. We provide OEM/ODM services to reduce time and save cost for customers.

4. The Part No. with the suffix "-I" indicates the products of industrial version, supporting working temperature -40 to 85 degree Celsius; the Part No. with the suffix "-C" indicates the products of commercial version, supporting working temperature 0 to 70 degree Celsius.

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